

## **8-BIT DMOS SINK DRIVER**

- FEATURES **N OR PW PACKAGE DMOS Process** (TOP VIEW) High Voltage Output (V<sub>ds</sub> = 30 V) N.C. [ □ <sup>v</sup>cc 1 20 **Output Current on Each Channel** 7 Y1 D1 2 19  $(I_{ds} Max = 200 mA)$ D2 TY2 3 18 Latch-Up Performance Exceeds 250 mA Per D3[ 4 17 7Y3 JEDEC Standard JESD-17 D4 5 16 7Y4 D5 [ 6 15 75 Y5 ESD Protection Exceeds JESD 22 7 **Y6** D6 🗌 14 2000-V Human Body Model (A114-A) D7 [ 8 13 1Y7 - 200-V Machine Model (A115-A) D8 🗌 9 12 <u>|</u> Y8 N.C. 10 🗌 GND 11 - 1000-V Charged Device Model (C101)
- LED Driver Application
- **Output Clamp Diode (Parasitic)**

## **APPLICATIONS**

- Lamp and Display (LED)
- Hammer
- Relay

## DESCRIPTION

The TLC59211 is an 8-bit LED and solenoid driver designed for 5-V V<sub>CC</sub> operation.

The TLC59211 is characterized for operation from -40°C to 85°C.

#### **ORDERING INFORMATION**<sup>(1)</sup>

T <sub>A</sub>	PACK	AGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 85°C	PDIP – N	Reel of 1000	TLC59211IN	Y59211	
-40 C 10 85 C	TSSOP – PW	Reel of 2000	TLC59211IPWR	Y59211	

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

Package drawings, thermal data, and symbolization are available at www.ti.com/packaging. (2)

#### (EACH LATCH)<sup>(1)</sup> INPUTS OUTPUT Y D H\* L Н L

**FUNCTION TABLE** 

(1) L: Low-level H: High-level

H\*: with pullup resistor



PRODUCTION DATA information is current as of publication date

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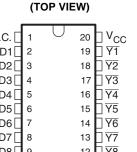
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N.C. - Not internally connected

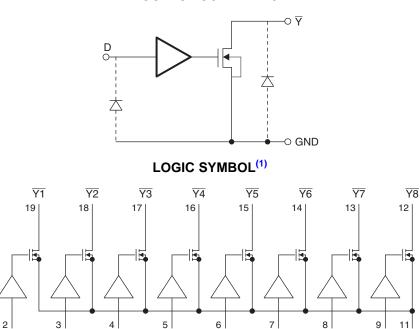
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#### **OUTPUT SCHEMATIC**



(1) This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12.

D4

D5

D6

D7

D8 GND

D3

## **ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

D1

over operating free-air temperature range (unless otherwise noted)

D2

				MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage range			-0.5	7	V	
D	Input voltage range		-0.5	7	V		
V <sub>ds</sub>	Output voltage range	H output		-0.5	32	V	
I <sub>ds</sub>	Output current range	1 bit for output low			200	mA	
I <sub>IK</sub>	Input clamp current	o current V <sub>I</sub> < 0 V			-20	mA	
0	Deckare thermal impedance $\binom{2}{2}$	N package			69	°C/W	
$\theta_{JA}$	Package thermal impedance <sup>(2)</sup>	PW package	PW package		83	°C/VV	
	Operating free-air temperature range				85	°C	
T <sub>stg</sub>	Storage temperature range				150	°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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(2) The package thermal impedance is calculated in accordance with JESD 51-7.



## **RECOMMENDED OPERATING CONDITIONS**

 $V_{CC}$  = 3 V to 5.5 V

			CONDITIONS	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage			3	5.5	V
V <sub>IH</sub>	High-level input voltage			$V_{\rm CC} \times 0.7$	V <sub>CC</sub>	V
V <sub>IL</sub>	Low-level input voltage			0	$V_{CC} \times 0.3$	V
V <sub>ds</sub>	Output voltage				30	V
		Nunashawa	Duty cycle < 42%		200	
	Output ourport	N package	Duty cycle < 100%		130	
Ids	Output current	DW/ nonline no	Duty cycle < 24%		200	mA
		PW package	Duty cycle < 100%		95	
T <sub>A</sub>	Operating free-air temperature	· · ·		-40	85	°C

## **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range,  $V_{CC} = 4.5$  V to 5.5 V,  $T_A = -40^{\circ\circ}$ C to 85°C (unless otherwise noted)

	PARAMETER	TEST CONDITION	S	MIN	TYP	MAX	UNIT
V <sub>t+</sub>	Positive-going input threshold	D, CLR, CLK				3.5	V
V <sub>t-</sub>	Negative-going input threshold	D, CLR, CLK		1.5			V
Vt	Hysteresis	D, CLR, CLK		0.5		2	V
I <sub>IH</sub>	High-level input current	$V_{CC} = 5.5 \text{ V}, \text{ V}_{I} = 5.5 \text{ V}$		0	1	μΑ	
IIL	Low-level input current	$V_{CC} = 5.5 \text{ V}, \text{ V}_{I} = 0 \text{ V}$		0	-1	μΑ	
I <sub>OZ</sub>	Leakage current	V <sub>ds</sub> = 30 V			5	μΑ	
I <sub>off</sub>	Leakage current	$V_{I} = 0$ to 5 V, $V_{O} = 0$ to 30 V, $V_{CC} = 0$		0	5	μΑ	
	Supply ourrent		Output = all OFF		0	5	۵
ICC	Supply current	$V_{I} = 0$ to 5 V, $V_{O} = 0$ to 30 V, $V_{CC} = 0$	Output = all ON		0	5	μA
		V <sub>CC</sub> = 4.5 V, I <sub>O</sub> = 100 mA	·		0.2	0.35	V
V <sub>OL</sub> Low-level output voltage		$V_{CC} = 4.5 \text{ V}, I_{O} = 200 \text{ mA}$		0.5	0.7	V	
r <sub>ON</sub>	ON-state resistance	V <sub>CC</sub> = 4.5 V, I <sub>O</sub> = 100 mA			2	3.5	Ω
Ci	Input capacitance	$V_{I} = V_{CC}$ or GND			5		pF

## SWITCHING CHARACTERISTICS

over operating free-air temperature range,  $V_{CC} = 4.5$  V to 5.5 V,  $T_A = -40^{\circ\circ}$ C to 85°C (unless otherwise noted)

PARAMETER	TEST	LOAD	т	<sub>A</sub> = 25°C		$T_A = -40^{\circ}C$ to $85^{\circ}C$		UNIT
PARAMETER	CONDITIONS	CAPACITANCE	MIN	ТҮР	MAX	MIN N	AX	UNIT
t <sub>TLH</sub>	Output = low to high	$\begin{array}{l} C_L = 30 \text{ pF},  \text{R}_L = 240  \Omega, \\ 24\text{-V pullup} \end{array}$		180	220		260	ns
t <sub>THL</sub>	Output = high to low	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		290	430		460	ns
t <sub>PLH</sub>	Output = low to high	$\begin{array}{l} C_{L}=30 \text{ pF}, \text{ R}_{L}=240 \Omega,\\ 24\text{-V pullup} \end{array}$		320	470		510	ns
t <sub>PHL</sub>	Output = high to low	$\begin{array}{l} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		320	470		510	ns

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## **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range,  $V_{CC} = 3 \text{ V}$  to 3.6 V,  $T_A = -40^{\circ\circ}\text{C}$  to 85°C (unless otherwise noted)

	PARAMETER	TEST CONDIT	IONS	MIN	TYP	MAX	UNIT
V <sub>t+</sub>	Positive-going input threshold	D				2.52	V
V <sub>t-</sub>	Negative-going input threshold	D		0.9			V
Vt	Hysteresis	D	0.33		1.32	V	
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 3.6V		0	1	μA	
I <sub>IL</sub>	Low-level input current	$V_{CC} = 3.6 V, V_{I} = 0 V$		0	-1	μA	
I <sub>OZ</sub>	Leakage current	V <sub>ds</sub> = 30 V			5	μA	
I <sub>off</sub>	Leakage current	$V_{I} = 0$ to 3.6 V, $V_{O} = 0$ to 30 V, $V_{C0}$		0	5	μΑ	
	Currate summert		Output = all OFF		0	5	
I <sub>CC</sub>	Supply current	$V_{I} = 0$ to 3.6 V, $V_{CC} = 3.6$ V		0	5	μA	
v		V 2)/ 1 100 mA				0.7	V
V <sub>OL</sub>	Low-level output voltage	$V_{CC} = 3 \text{ V}, \text{ I}_{OL} = 100 \text{ mA}$		0.35		0.7	V
r <sub>ON</sub>	ON-state resistance	V <sub>CC</sub> = 3 V, I <sub>O</sub> = 100 mA			3.5	7	Ω
Ci	Input capacitance	$V_{I} = V_{CC}$ or GND			5		pF

## SWITCHING CHARACTERISTICS

over operating free-air temperature range,  $V_{CC}$  = 3 V to 3.6 V,  $T_A$  = -40°°C to 85°C (unless otherwise noted)

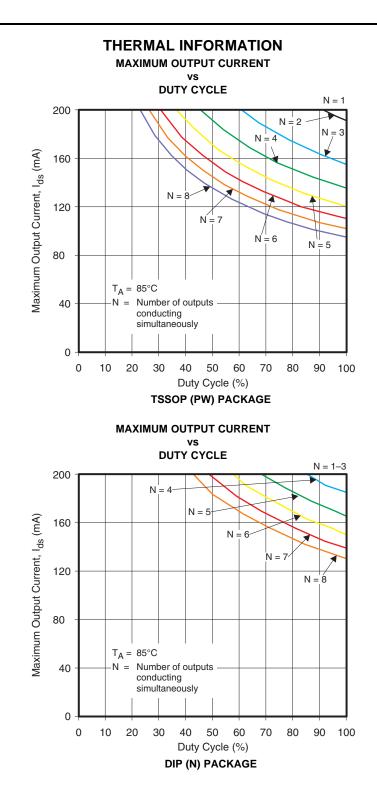
PARAMETER	TEST	LOAD	т	<sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to 85	°C	UNIT
FARAMETER	CONDITIONS	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
t <sub>TLH</sub>	Output = low to high	$\begin{array}{c} C_{L}=30 \text{ pF},  R_{L}=240  \Omega,\\ 24\text{-V pullup} \end{array}$		200	450		450	ns
t <sub>THL</sub>	Output = high to low	$C_L = 30 \text{ pF}, R_L = 240 \Omega,$ 24-V pullup		300	450		480	ns
t <sub>PLH</sub>	Output = low to high	$\begin{array}{c} C_{L}=30 \text{ pF},  R_{L}=240  \Omega,\\ 24\text{-V pullup} \end{array}$		450	650		800	ns
t <sub>PHL</sub>	Output = high to low	$\begin{array}{c} C_L = 30 \text{ pF},  \text{R}_L = 240  \Omega, \\ 24\text{-V pullup} \end{array}$		450	650		800	ns

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**6 A** 7

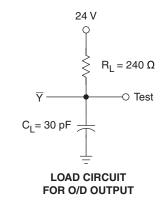
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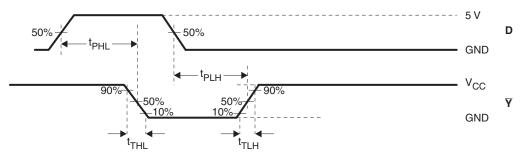
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## PARAMETER MEASUREMENT INFORMATION





#### **VOLTAGE WAVEFORMS**

- A. C<sub>L</sub> includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  3 ns, and t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

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#### Figure 1. Test Circuit and Voltage Waveforms

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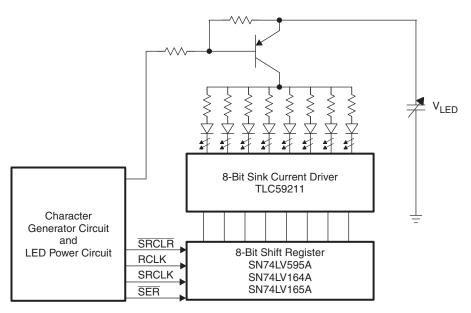
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## TLC59211

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## **APPLICATION INFORMATION**





## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLC59211IN	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC59211IPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## PACKAGE MATERIALS INFORMATION

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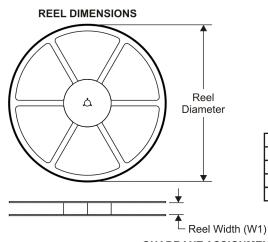
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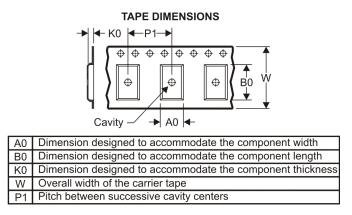
Pin1

Quadrant

Q1

## TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



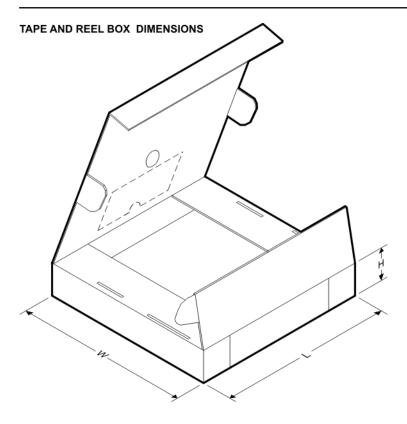
All dimensions are nominal											
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)
TLC59211IPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0

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## PACKAGE MATERIALS INFORMATION

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59211IPWR	TSSOP	PW	20	2000	346.0	346.0	33.0

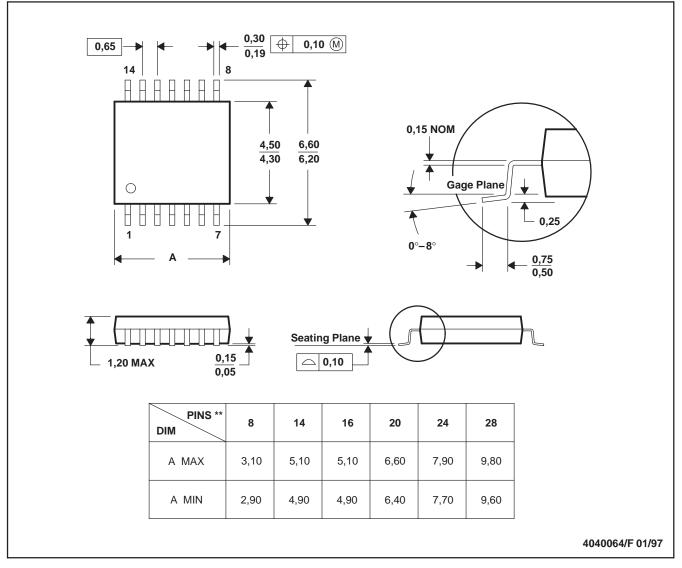
## **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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